

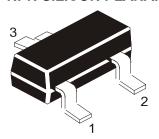
Continental Device India Limited

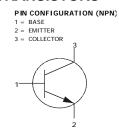
An ISO/TS 16949, ISO 9001 and ISO 14001 Certified Company





NPN SILICON PLANAR EPITAXIAL TRANSISTORS





BC846, BC847, BC848

SOT-23
Formed SMD Package
For Lead Free Parts, Device Part #
will be Prefixed with "T"

BC846 =1D BC846A=1A BC846B=1B

Marking

BC846B=1B BC847 =1H

BC847A=1E

BC847B=1F BC847C=1G

BC848 =1M

BC848A=1J

BC848B=1K

BC848C=1L

For use in Driver Stages of Audio Amplifier in Thick and Thin-film Hybrid Circuits

ABSOLUTE MAXIMUM RATINGS (T_a=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	BC846	BC847	BC848	UNITS
Collector Base Voltage	V _{CBO}	80	50	30	V
Collector Emitter Voltage (V _{BE} =0V)	V _{CES}	80	50	30	V
Collector Emitter Voltage	V _{CEO}	65	45	30	V
Emitter Base Voltage	V _{EBO}	6	6	5	V
Collector Current (DC)	Ic		•	mA	
Collector Current - Peak	I _{CM}				
Emitter Current - Peak	- I _{EM}			mA	
Base Current - Peak	I _{BM}			mA	
Power Dissipation upto T _{amb} =25°C	P _{tot} *			mW	
Storage Temperature	T _{stg}		°C		
Junction Temperature	Tj		°C		

THERMAL RESISTANCE

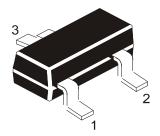
From junction to ambient	R _{th(j-a)} *	500	K/W
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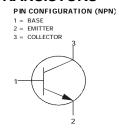
^{**}Mounted on a ceramic substrate of 8mm x 10 mm x 0.7mm

BC846_848Rev_2 170407E

NPN SILICON PLANAR EPITAXIAL TRANSISTORS

BC846, BC847, BC848





SOT-23 Formed SMD Package

For Lead Free Parts, Device Part # will be Prefixed with "T"

ABSOLUTE MAXIMUM RATINGS (T₂=25°C unless specified otherwise)

DESCRIPTION	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNITS
Collector Cut off Current	I _{CBO}	$V_{CB}=30V$, $I_{E}=0$			15	nA
		V_{CB} =30V, I_{E} =0, T_{j} =150 °C			5	μΑ
Base Emitter on Voltage	V _{BE(on)} *	I _C =2mA, V _{CE} =5V	0.58		0.70	V
		$I_C=10mA, V_{CE}=5V$			0.77	
Collector Emitter Saturation Voltage	$V_{CE(Sat)}$	$I_C=10$ mA, $I_B=0.5$ mA			0.25	V
		$I_C=100$ mA, $I_B=5$ mA			0.60	
Base Emitter Saturation Voltage	V _{BE(Sat)} ***	$I_C=10$ mA, $I_B=0.5$ mA		0.7		V
		$I_C=100$ mA, $I_B=5$ mA		0.9		
DC Current Gain	h _{FE}	$I_C=10\mu A, V_{CE}=5V$				
		BC846A/BC847A/BC848A		90		
		BC846B/BC847B/BC848B		150		
		BC847C/BC848C		270		
		I _C =2mA, V _{CE} =5V				
		BC846	110		450	
		BC847/BC848	110		800	
		BC846A/BC847A/BC848A	110		220	
		BC846B/BC847B/BC848B	200		450	
		BC847C/BC848C	420		800	
Collector Capacitance	C _c	I_E =ie=0, V_{CB} =10V, f=1MHz		2.5		pF
Transition Frequency	f _T	I _C =10mA, V _{CE} =5V,f=100MHz	100			MHz
Noise Figure	NF	$I_C=0.2$ mA, $V_{CE}=5$ V			10	dB
		R_s =2k Ω , f=1KHz, B=200Hz				

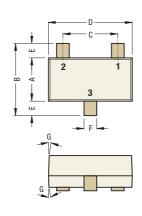
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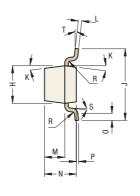
 $^{^*}V_{BE\,(on)}$ decreases by about 2mV/K with increasing temperature. ***V_BE(sat) decreases by about 1.7mV/K with increasing temperature.

SOT-23 Formed SMD Package

SOT-23 SMD Plastic Package





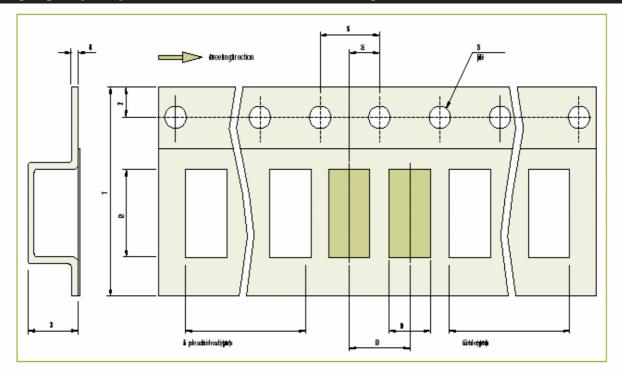


DIM	Min	Max			
Α	1.20	1.40			
В	2.10	2.64			
С	1.85	1.95			
D	2.80	3.04			
Е	0.54	0.67			
F	0.30	0.50			
G	3°				
Н	_	1.30			
J	2.10	2.64			

DIM	Min	Max					
K	7°						
L	0.08	0.20					
М	0.58	0.62					
N	0.70	1.02					
0	0.21	_					
Р	0.02	0.15					
R	_	0.08					
S	2°	8°					
Т	2°	10°					

Pin Configuration Pin 1: Base Pin 2: Emitter Pin 3: Collector

Packaging Tape Specifications for SMD Packages

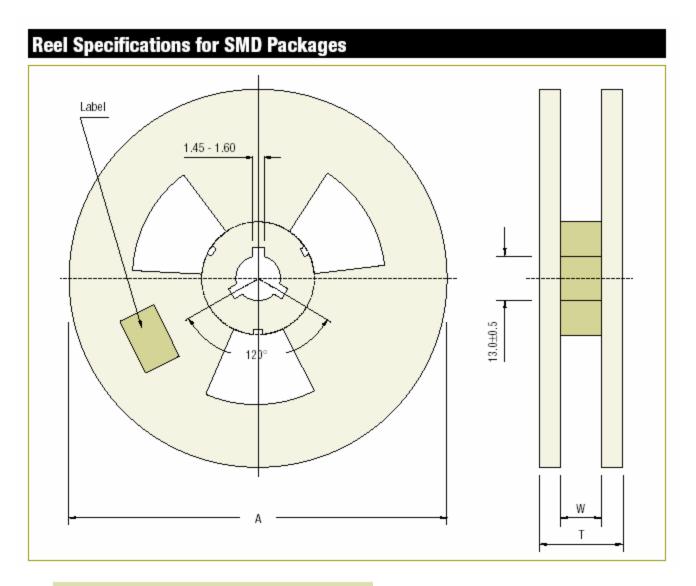


SMD Tape Specifications (8-12 mm)

Device	D1	D2	D3	Tí	T2	T3	T4	S1	S2	S3
						Max	Max			Dia
	mm	mm	mm	mm	mm	mm	mm	mm	mm	mm
S0T-23	3.2±0.1	2.8±0.1	4.0±0.1	8.0±0.2	1.75±0.1	1.60	0.35	4.0±0.1	2.0±0.1	1.5±0.1

Packaging Specifications

Package / Case Type	Packaging Type	Std. Packing		Inner Carton		Outer Carton			
		Qty	Qty Size L x W x H Gross Weight		Oty	Size L x W x H	Gross Weight		
				(cm)	(Kg)		(cm)	(Kg)	
S0T-23	T&R	3,000	15K	19 x 19 x 8	0.6	51K	23 x 23 x 23	2.2	
	T&R	3,000	15K	19 x 19 x 8	0.6	408K	48 x 48 x 51	20.2	
	T&R	10,000	50K	35.5 x 35.5 x 8.9	2.4	350K	48 x 48 x 51	19.2	



Reel Specifications

Package	Tape	Reel Dia.	Devices	Inside	Reel
	Width		per Reel	Thickness	Thickness
		A - Max	and MOQ	W	T - Max
SOT-23	8	180	3,000	8.4±2	14.4
	8	330	10,000	8.4±2	14.4

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
 - 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving/support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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